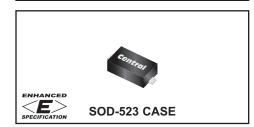


ENHANCED SPECIFICATION SURFACE MOUNT SILICON SCHOTTKY DIODE





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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMOSH-4E is an enhanced version of the CMOSH-3 silicon Schottky diode in an SOD-523 surface mount package.

MARKING CODE: 4E

ENHANCED SPECIFICATIONS:

- ♦ I_F from 100 mA MAX to 200 mA MAX
- ♦ BV_R from 30V MIN to 40V MIN
- ♦ V_F from 1.0V MAX to 0.8V MAX

	I RATINGS: (T _A =25°C) etitive Reverse Voltage	SYMBOL ^V RRM	Δ	10	UNITS V
	us Forward Current		-	00	mA
Peak Repe	etitive Forward Current	I _{FRM}	3	50	mA
Peak Forw	vard Surge Current, tp=10ms	IFSM	7	50	mA
Power Dis	sipation	PD	2	50	mW
Operating and Storage Junction Temperature		т _Ј , Т _{stg}	-65 to +150		°C
Thermal Resistance		Θ_{JA}	500		°C/W
ELECTRIC SYMBOL IR IR BVR VF VF VF VF VF VF CJ	CAL CHARACTERISTICS: $(T_A=25^{\circ}C u)$ TEST CONDITIONS $V_R=25V$ $V_R=25V, T_A=100^{\circ}C$ $I_R=100\mu A$ $I_F=2.0mA$ $I_F=15mA$ $I_F=100mA$ $I_F=200mA$ $V_R=1.0V, f=1.0MHz$	unless otherwise MIN 40	noted) TYP 90 25 50 0.29 0.37 0.51 0.65 7.0	MAX 500 100 0.33 0.42 0.80 1.0	UNITS nA μA V V V V V V PF
t _{rr}	I _F =I _R =10mA, I _{rr} =1.0mA, R _L =1000	2		5.0	ns
– .					

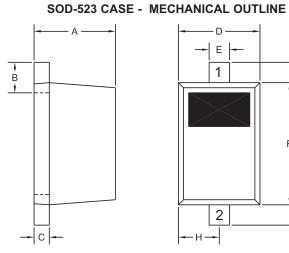
Enhanced specification.
Additional Enhanced specification.

R5 (16-February 2016)



CMOSH-4E

ENHANCED SPECIFICATION SURFACE MOUNT SILICON SCHOTTKY DIODE



- D --- E 1 G F 2 -н--R3

LEAD CODE:	
1) Cathode	
2) Anode	

MARKING CODE: 4E

DIMENSIONS								
	INCHES		MILLIMETERS					
SYMBOL	MIN	MAX	MIN	MAX				
A	0.020	0.031	0.50	0.80				
В	0.008	0.016	0.20	0.40				
С	0.002	0.008	0.05	0.20				
D	0.028	0.035	0.70	0.90				
E	0.008	0.014	0.20	0.35				
F	0.039	0.055	1.00	1.40				
G	0.055	0.071	1.40	1.80				
Н	0.016		0.40					
SOD-523 (REV: R3)								

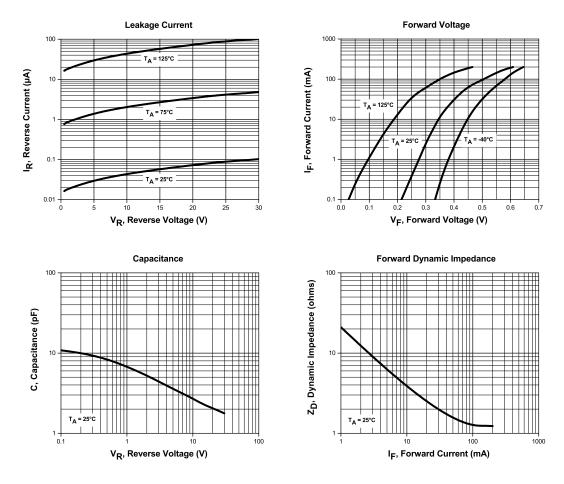
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CMOSH-4E

ENHANCED SPECIFICATION SURFACE MOUNT SILICON SCHOTTKY DIODE



TYPICAL ELECTRICAL CHARACTERISTICS

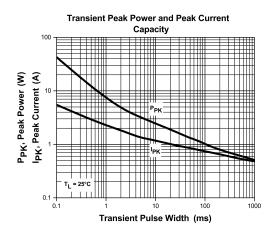
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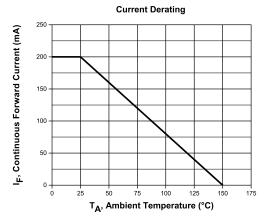


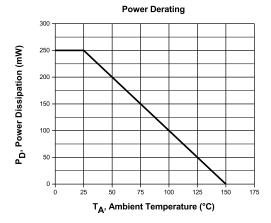


ENHANCED SPECIFICATION SURFACE MOUNT SILICON SCHOTTKY DIODE



TYPICAL ELECTRICAL CHARACTERISTICS





R5 (16-February 2016)

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OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

Special wafer diffusions

· Custom product packing

- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

· Custom bar coding for shipments

Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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